Low-Voltage CMOS Octal Transceiver

With 5 V–Tolerant Inputs and Outputs (3–State, Non–Inverting)

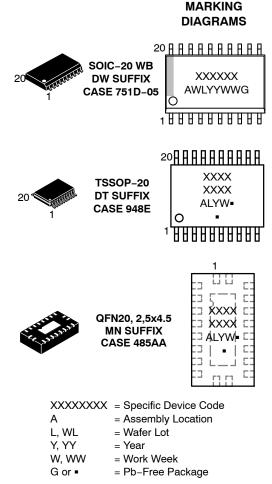
MC74LCX245

The MC74LCX245 is a high performance, non-inverting octal transceiver operating from a 1.65 to 5.5 V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A V_I specification of 5.5 V allows MC74LCX245 inputs to be safely driven from 5 V devices if V_{CC} is less than 5.0 V. The MC74LCX245 is suitable for memory address driving and all TTL level bus oriented transceiver applications.

Current drive capability is 24 mA at both A and B ports at $V_{CC} = 3.0$ V. The Transmit/Receive (T/\overline{R}) input determines the direction of data flow through the bi-directional transceiver. Transmit (active-HIGH) enables data from A ports to B ports; Receive (active-LOW) enables data from B to A ports. The Output Enable input, when HIGH, disables both A and B ports by placing them in a HIGH Z condition.

Features

- Designed for 1.65 to 5.5 V V_{CC} Operation
- 5 V Tolerant Interface Capability With 5 V TTL Logic
- Supports Live Insertion and Withdrawal
- I_{OFF} Specification Guarantees High Impedance When $V_{CC} = 0 V$
- LVTTL Compatible
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability at V_{CC} = 3.0 V
- Near Zero Static Supply Current in All Three Logic States (10 μA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 100 mA
- ESD Performance: Human Body Model > 2000 V
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 7.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

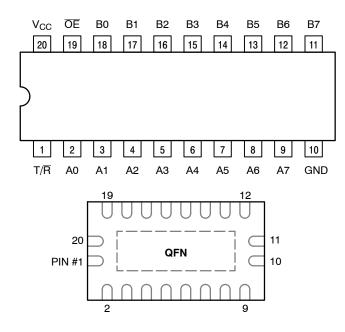


Figure 1. Pinout (Top View)

PIN NAMES

PINS	FUNCTION
ŌE	Output Enable Input
T/R	Transmit/Receive Input
A0-A7	Side A 3-State Inputs or 3-State Outputs
B0-B7	Side B 3–State Inputs or 3–StateOutputs

TRUTH TABLE

INF	PUTS	OPERATING MODE
ŌĒ	T/R	Non-Inverting
L	L	B Data to A Bus
L	н	A Data to B Bus
н	х	Z

H = High Voltage Level

L = Low Voltage Level

Z = High Impedance State

X = High or Low Voltage Level and Transitions are Acceptable

For I_{CC} reasons, Do Not Float Inputs

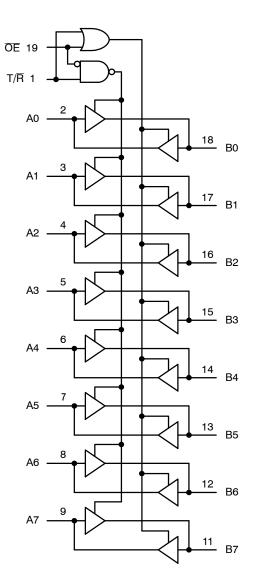


Figure 2. Logic Diagram

MAXIMUM RATINGS

Symbol	Parameter	Condition	Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +6.5	V
VI	DC Input Voltage (Note 1)		-0.5 to +6.5	V
Vo	DC Output Voltage (Note 1)	Active-Mode (High or Low State)	–0.5 to V _{CC} + 0.5	V
		Tri-State Mode	-0.5 to +6.5	
		Power–Down Mode (V _{CC} = 0 V)	-0.5 to +6.5	
I _{IK}	DC Input Diode Current	V _{IN} < GND	-50	mA
I _{OK}	DC Output Diode Current	V _{OUT} < GND	-50	mA
Ι _Ο	DC Output Source/Sink Current		±50	mA
I _{CC} or I _{GND}	DC Supply Current per Supply Pin or Ground Pin		±100	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
TL	Lead Temperature, 1 mm from Case for 10 secs		260	°C
TJ	Junction Temperature under Bias		+150	°C
θ_{JA}	Thermal Resistance (Note 2)	SOIC-20W	96	°C/W
		WQFN20	99	
		QFN20	111	
		TSSOP-20	150	
PD	Power Dissipation in Still Air	SOIC-20W	1302	mW
		WQFN20	1256	
		QFN20	1127	
		TSSOP-20	833	
MSL	Moisture Sensitivity	SOIC-20W	Level 3	-
		All other packages	Level 1	1
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V_{ESD}	ESD Withstand Voltage (Note 3)	Human Body Model	>2000	V
		Charged Device Model	N/A	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

I_O absolute maximum rating must be observed.
 I_O absolute maximum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD20-A115A (Machine Model) be discontinued.

RECOMMENDED OPERATING CONDITIONS (Note 4)

Symbol		Parameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	Operating	1.65	2.5, 3.3	5.5	V
		Data Retention Only	1.5	2.5, 3.3	5.5	
VI	Digital Input Voltage		0	-	5.5	V
Vo	Output Voltage	Active-Mode (High or Low State)	0	-	V _{CC}	V
		Tri-State Mode	0	-	5.5	
		Power–Down Mode (V _{CC} = 0 V)	0	-	5.5	
T _A	Operating Free-Air Temperatu	ire	-55		+125	°C
t _r , t _f	Input Rise or Fall Rate	V _{CC} = 1.65 V to 1.95 V	0	-	20	ns/V
		V_{CC} = 2.3 V to 2.7 V	0	-	20	
		V_{IN} from 0.8 V to 2.0 V, V_{CC} = 3.0 V	0	-	10	
		V_{CC} = 4.5 V to 5.5 V	0	-	5	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS

				$T_A = -40^\circ$	C to +85°C	$T_{A} = -55^{\circ}C$	C to +125°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Min	Max	Min	Мах	Unit
V _{IH}	High-Level Input		1.65 to 1.95	$0.65 \times V_{CC}$		$0.65 \times V_{CC}$		V
	Voltage		2.3 to 2.7	1.7		1.7		1
			2.7 to 3.6	2.0		2.0		1
			4.5 to 5.5	$0.7 \times V_{CC}$		$0.7 \times V_{CC}$		1
VIL	Low-Level Input		1.65 to 1.95		$0.35 \times V_{CC}$		$0.35 imes V_{CC}$	V
	Voltage		2.3 to 2.7		0.7		0.7	1
			2.7 to 3.6		0.8		0.8	1
			4.5 to 5.5		$0.3 \times V_{CC}$		$0.3 imes V_{CC}$	1
V _{OH}	High-Level Output Voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$ $I_{OH} = -100 \ \mu\text{A}$ $I_{OH} = -4 \ \text{mA}$ $I_{OH} = -8 \ \text{mA}$ $I_{OH} = -12 \ \text{mA}$ $I_{OH} = -16 \ \text{mA}$	1.65 to 5.5 1.65 2.3 2.7 3.0	V _{CC} – 0.1 1.2 1.8 2.2 2.4		V _{CC} – 0.1 1.2 1.8 2.2 2.4		V
		$I_{OH} = -24 \text{ mA}$ $I_{OH} = -32 \text{ mA}$	3.0 4.5	2.2 3.8	-	2.2 3.8		
V _{OL}	Low-Level Output Voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$ $I_{OL} = 100 \ \mu\text{A}$ $I_{OL} = 4 \ \text{mA}$ $I_{OL} = 8 \ \text{mA}$ $I_{OL} = 12 \ \text{mA}$ $I_{OL} = 16 \ \text{mA}$ $I_{OL} = 24 \ \text{mA}$ $I_{OL} = 32 \ \text{mA}$	1.65 to 5.5 1.65 2.3 2.7 3.0 3.0 4.5	- - - - - -	0.1 0.45 0.6 0.4 0.4 0.55 0.6	- - - - - -	0.1 0.45 0.6 0.4 0.4 0.55 0.6	V
Ιį	Input Leakage Current	V _I = 0 to 5.5 V	3.6	-	±5.0	-	±5.0	μΑ
I _{OZ}	3-State Output Leakage Current	$V_{I} = V_{IH} \text{ or } V_{IL},$ $V_{O} = 0 \text{ V to } 5.5 \text{ V}$	3.6	-	±5.0	-	±5.0	μΑ
I _{OFF}	Power Off Leakage Current	$V_{I} = 5.5 V \text{ or}$ $V_{O} = 5.5 V$	0	_	10	-	10	μΑ

DC ELECTRICAL CHARACTERISTICS (continued)

				$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		T _A = -55°C	to +125°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Min	Max	Min	Max	Unit
I _{CC}	Quiescent Supply Current	$V_{I} = 5.5 V \text{ or GND}$	3.6	-	10	-	10	μΑ
ΔI _{CC}	Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6 V$	2.3 to 3.6	_	500	-	500	μΑ

AC ELECTRICAL CHARACTERISTICS

				T _A = -40	°C to +85°C	$T_A = -55^\circ$	C to +125°C	
Symbol	Parameter	Test Conditions	V _{CC} (V)	Min	Мах	Min	Max	Unit
t _{PLH} , t _{PHL}	Propagation	See Figures 3 and 4	1.65 to 1.95	_	10.3	-	10.3	ns
	Delay, D to O		2.3 to 2.7	_	8.4	-	8.4	
			2.7	-	8.0	-	8.0	
			3.0 to 3.6	-	7.0	-	7.0	
			4.5 to 5.5	-	5.0	-	5.0	
t _{PZH} , t _{PZL}	Output Enable	See Figures 3 and 4	1.65 to 1.95	-	13.0	-	13.0	ns
	Time, OE to O		2.3 to 2.7	-	10.5	-	10.5	
			2.7	-	9.5	-	9.5	
			3.0 to 3.6	-	8.5	-	8.5	
			4.5 to 5.5	-	7.0	-	7.0	
t _{PHZ} , t _{PLZ}	Output Disable	See Figures 3 and 4	1.65 to 1.95	-	11.0	-	11.0	ns
	Time, OE to O		2.3 to 2.7	-	9.0	-	9.0	
			2.7	-	8.5	-	8.5	
			3.0 to 3.6	-	7.5	-	7.5	
			4.5 to 5.5	-	6.0	-	6.0	
t _{OSHL} ,	Output to Output		1.65 to 1.95	-	-	-	-	ns
t _{OSLH}	Skew (Note 5)		2.3 to 2.7	-	1.0	-	1.0	
			2.7	-	1.0	-	1.0	7
			3.0 to 3.6	-	1.0	-	1.0	7
			5.0	-	1.0	-	1.0	

5. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

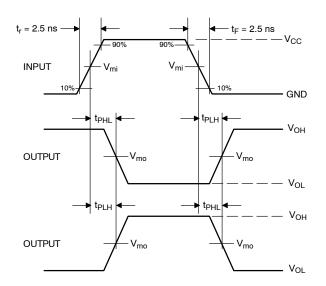
DYNAMIC SWITCHING CHARACTERISTICS

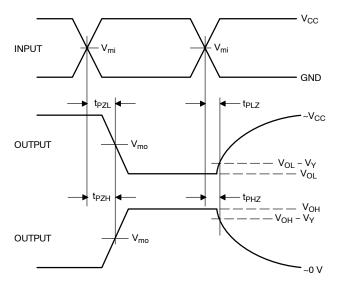
			T _A = +25°C			
Symbol	Characteristic	Condition	Min	Тур	Max	Unit
V _{OLP}	Dynamic LOW Peak Voltage (Note 6)	$ \begin{array}{l} V_{CC} = 3.3 \text{ V}, \ C_L = 50 \text{ pF}, \ V_{IH} = 3.3 \text{ V}, \ V_{IL} = 0 \text{ V} \\ V_{CC} = 2.5 \text{ V}, \ C_L = 30 \text{ pF}, \ V_{IH} = 2.5 \text{ V}, \ V_{IL} = 0 \text{ V} \end{array} $		0.8 0.6		V V
V _{OLV}	Dynamic LOW Valley Voltage (Note 6)			-0.8 -0.6		V V

 Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

CAPACITIVE CHARACTERISTICS

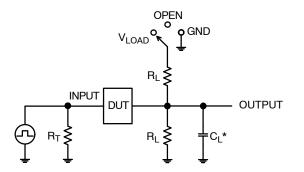
Symbol	Parameter	Parameter Condition		Unit
C _{IN}	Input Capacitance	V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	7	pF
C _{I/O}	Input/Output Capacitance	V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	8	pF
C _{PD}	Power Dissipation Capacitance	10 MHz, V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	25	pF





V _{CC} , V	R_{L}, Ω	C _L , pF	V _{LOAD}	V _{mi} , V	V _{mo} , V	V _Y , V
1.65 to 1.95	500	30	$2 \times V_{CC}$	V _{CC} /2	V _{CC} /2	0.15
2.3 to 2.7	500	30	$2 \times V_{CC}$	V _{CC} /2	V _{CC} /2	0.15
2.7	500	50	6 V	1.5	V _{CC} /2	0.3
3.0 to 3.6	500	50	6 V	1.5	V _{CC} /2	0.3
4.5 to 4.5	500	50	$2 \times V_{CC}$	V _{CC} /2	V _{CC} /2	0.3

Figure 3. Switching Waveforms



 C_L includes probe and jig capacitance R_T is Z_{OUT} of pulse generator (typically 50 $\Omega)$ f = 1 MHz

Test	Switch Position
t _{PLH} / t _{PHL}	Open
t _{PLZ} / t _{PZL}	V _{LOAD}
t _{PHZ} / t _{PZH}	GND

Figure 4. Test Circuit

ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
MC74LCX245DWG	LCX245	SOIC-20 WB	38 Units / Rail
MC74LCX245DWR2G	LCX245	SOIC-20 WB	1000 / Tape & Reel
MC74LCX245DTG	LCX 245	TSSOP-20	75 Units / Rail
MC74LCX245DTR2G	LCX 245		
MC74LCX245DTR2G-Q*	LCX 245		
MC74LCX245MNTWG	LCX 245	QFN20, 2.5x4.5	3000 / Tape & Reel (4mm pitch carrier tape)

DISCONTINUED (Note 7)

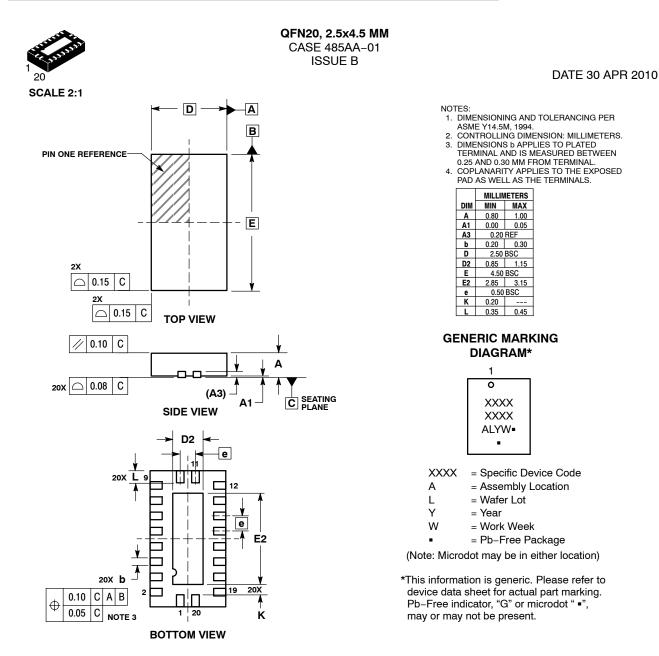
NLV74LCX245DTR2G*	LCX 245	TSSOP-20 (Pb-Free)	2500 Tape & Reel
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†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

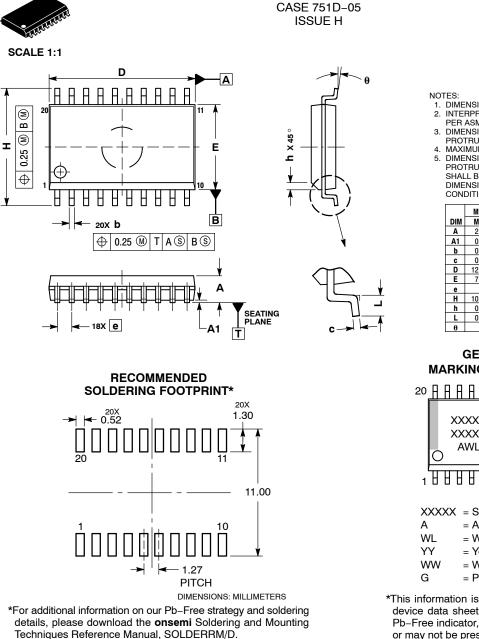
7. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.





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semi



SOIC-20 WB

DATE 22 APR 2015

- NOTES:
 DIMENSIONS ARE IN MILLIMETERS.
 INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD
- DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		
DIM	MIN MAX		
Α	2.35	2.65	
A1	0.10	0.25	
b	0.35	0.49	
C	0.23 0.32		
D	12.65	12.95	
E	7.40	7.60	
е	1.27 BSC		
H	10.05	10.55	
h	0.25	0.75	
L	0.50	0.90	
θ	0 °	7 °	

GENERIC **MARKING DIAGRAM***

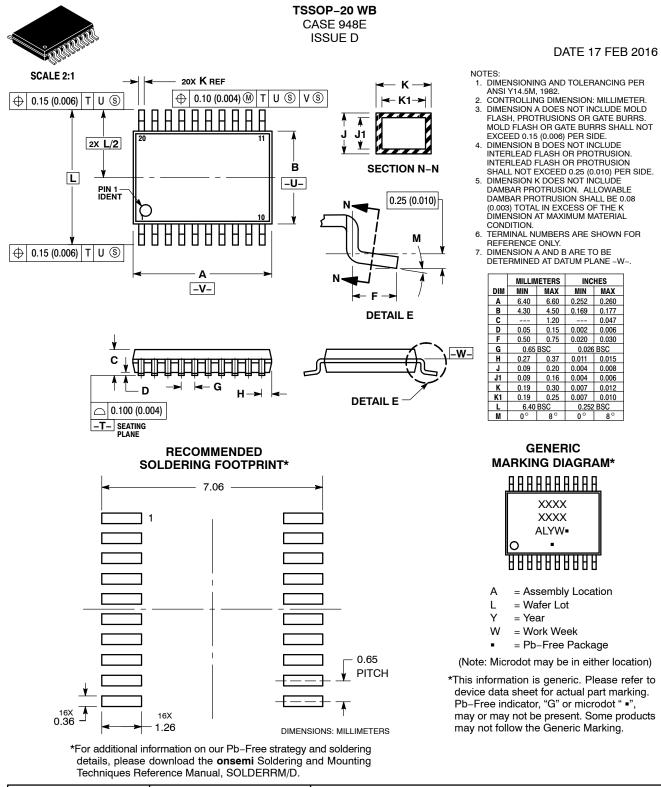
20	A	<u> </u>	a
	С	XXXXXXXXXXXX XXXXXXXXXXXX AWLYYWWG	
1 1	H	88888888	J
A W Y	′L Y	 (XX = Specific Device (= Assembly Locati Wafer Lot Year Work Week 	
Ŵ	W	/ = Work Week	

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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